**Vishay Semiconductors** 



"High Side Chopper" IGBT SOT-227 (Trench IGBT), 100 A



SOT-227

PRODUCT SUMMARY					
V <sub>CES</sub>	1200 V				
I <sub>C</sub> DC	100 A at 71 °C				
V <sub>CE(on)</sub> typical at 100 A, 25 °C	2.36 V				
Speed	8 kHz to 30 kHz				
Package	SOT-227				
Circuit	High side switch				

### FEATURES

- Trench IGBT technology
- Very low V<sub>CE(on)</sub>
- Square RBSOA
- HEXFRED<sup>®</sup> clamping diode
- 10 µs short circuit capability
- Fully isolated package
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting on heatsink
- · Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		1200	V	
Continuous collector current	L.	T <sub>C</sub> = 25 °C	134		
Continuous collector current	Ι <sub>C</sub>	T <sub>C</sub> = 80 °C	92		
Pulsed collector current	I <sub>CM</sub>		270	А	
Clamped inductive load current	I <sub>LM</sub>		270	A	
Diode continuous forward current	١ <sub>F</sub>	T <sub>C</sub> = 25 °C	87		
		T <sub>C</sub> = 80 °C	59		
Gate to emitter voltage	V <sub>GE</sub>		± 20	V	
Power dissipation, IGBT	P <sub>D</sub>	T <sub>C</sub> = 25 °C	463		
		T <sub>C</sub> = 80 °C	260	W	
Power dissipation, diode		T <sub>C</sub> = 25 °C	338	vv	
	P <sub>D</sub>	T <sub>C</sub> = 80 °C	190		
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 min	2500	V	





www.vishay.com

## **Vishay Semiconductors**

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V <sub>BR(CES)</sub>	<sub>S)</sub> V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA 1200 -		-	-		
		$V_{GE} = 15 \text{ V}, I_{C} = 50 \text{ A}$	-	1.79	2.33	v	
Collector to amittar valtage	V	$V_{GE} = 15 \text{ V}, I_{C} = 100 \text{ A}$	-	2.36	2.85		
Collector to emitter voltage	V <sub>CE(on)</sub>	$V_{GE}$ = 15 V, I <sub>C</sub> = 50 A, T <sub>J</sub> = 125 °C	-	2.05	2.62		
		$V_{GE}$ = 15 V, I <sub>C</sub> = 100 A, T <sub>J</sub> = 125 °C	-	2.8	3.42		
Gate threshold voltage	V <sub>GE(th)</sub>	$V_{CE} = V_{GE}$ , $I_C = 500 \ \mu A$	5	5.8	7		
Temperature coefficient of threshold voltage	$V_{GE(th)}\!/\!\Delta T_J$	$V_{CE}$ = $V_{GE}$ , $I_C$ = 1 mA (25 °C to 125 °C)	-	-15.6	-	mV/°C	
		V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V	-	0.5	100	μA	
Collector to emitter leakage current		$V_{GE} = 0 \text{ V},  V_{CE} = 1200 \text{ V},  \text{T}_{\text{J}} = 125 ^{\circ}\text{C}$	-	0.052	2	mA	
Diode reverse breakdown voltage	V <sub>BR</sub>	I <sub>R</sub> = 1 mA	1200	-	-	V	
		$I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}$	-	2.53	3.55	1	
Diode forward voltage drop	V <sub>FM</sub>	I <sub>C</sub> = 100 A, V <sub>GE</sub> = 0 V	-	3.32	4.35	v	
		$I_{C} = 50 \text{ A}, V_{GE} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$	-	2.66	3.70		
		$I_{C}$ = 100 A, $V_{GE}$ = 0 V, $T_{J}$ = 125 °C	-	3.7	4.50	1	
	I	$V_{R} = V_{R}$ rated	-	4	50	μA	
Diode reverse leakage current	I <sub>RM</sub>	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	0.6	3	mA	
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA	

PARAMETER	SYMBOL	TEST CONDIT	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg			-	400	-	
Gate to emitter charge (turn-on)	Q <sub>ge</sub>	$I_{\rm C} = 100$ A, $V_{\rm CC} = 600$ V,	V <sub>GE</sub> = 15 V	-	120	-	nC
Gate to collector charge (turn-on)	Q <sub>gc</sub>		-	170	-		
Turn-on switching loss	Eon	I <sub>C</sub> = 100 A, V <sub>CC</sub> = 600 V,		-	21.9	-	- mJ
Turn-off switching loss	E <sub>off</sub>	$V_{GE} = 15 \text{ V}, \text{ R}_{g} = 5 \Omega,$		-	5.48	-	
Total switching loss	E <sub>tot</sub>	L = 500 µH		-	27.38	-	
Turn-on switching loss	Eon		Energy losses	-	23.6	-	
Turn-off switching loss	E <sub>off</sub>		include tail and	-	7.65	-	
Total switching loss	E <sub>tot</sub>	$ \begin{split} & I_C = 100 \text{ A}, V_{CC} = 600 \text{ V}, \\ & V_{GE} = 15 \text{ V}, \text{ R}_g = 5 \Omega, \\ & L = 500 \ \mu\text{H}, \text{ T}_J = 125 \ ^\circ\text{C} \end{split} $	diode recovery (see fig. 18)	-	31.25	-	
Turn-on delay time	t <sub>d(on)</sub>			-	195	-	ns
Rise time	tr			-	259	-	
Turn-off delay time	t <sub>d(off)</sub>			-	188	-	
Fall time	t <sub>f</sub>			-	212 -		1
Reverse bias safe operating area	RBSOA	$\begin{array}{l} T_{J} = 150 \ ^{\circ}\text{C}, \ I_{C} = 270 \ \text{A}, \ R_{g} = 22 \ \Omega, \\ V_{GE} = 15 \ \text{V} \ \text{to} \ 0 \ \text{V}, \ V_{CC} = 900 \ \text{V}, \\ V_{P} = 1200 \ \text{V} \end{array}$		Fullsquare			
Short circuit safe operating area	SCSOA	$T_J = 150 \ ^{\circ}C, R_g = 22 \ \Omega,$ $V_{GE} = 15 \ V \ to \ 0 \ V, V_{CC} = 900 \ V,$ $V_P = 1200 \ V$			10		μs
Diode reverse recovery time	t <sub>rr</sub>			-	129	161	ns
Diode peak reverse current	l <sub>rr</sub>	I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 200 V - 11 1				14	Α
Diode recovery charge	Q <sub>rr</sub>				700	1046	nC
Diode reverse recovery time	t <sub>rr</sub>	l <sub>F</sub> = 50 A, dl <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 200 V, T <sub>J</sub> = 125 °C		-	208	257	ns
Diode peak reverse current	۱ <sub>rr</sub>			-	17	21	А
Diode recovery charge	Q <sub>rr</sub>			-	1768	2698	nC

Revision: 11-Jun-15

2

Document Number: 93100

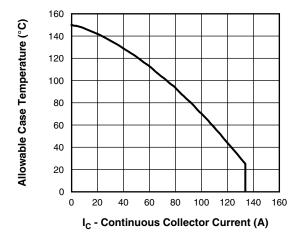
For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u> www.vishay.com

SHAY

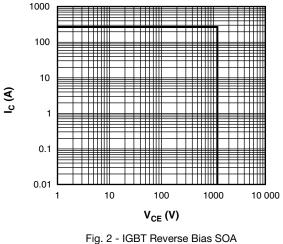
# VS-GT100NA120UX

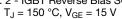
## **Vishay Semiconductors**

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40	-	150	°C
Junction to case	P		-	-	0.27	
Diode	R <sub>thJC</sub>		-	-	0.37	°C/W
Case to heatsink	R <sub>thCS</sub>	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque			-	-	1.3	Nm
Case style		SOT-227				









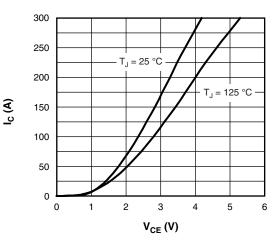


Fig. 3 - Typical IGBT Collector Current Characteristics

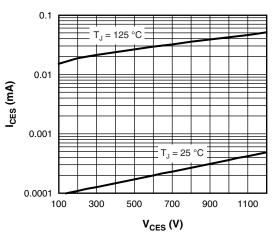


Fig. 4 - Typical IGBT Zero Gate Voltage Collector Current



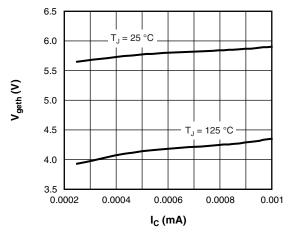
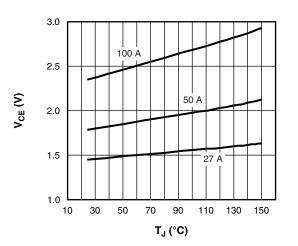
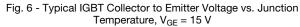
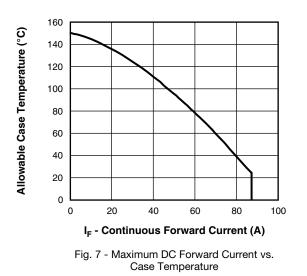


Fig. 5 - Typical IGBT Threshold Voltage







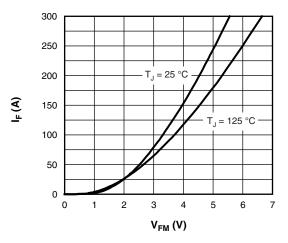
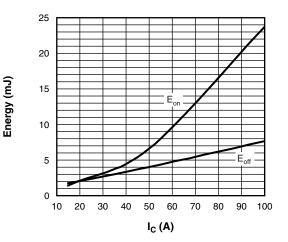


Fig. 8 - Typical Diode Forward Characteristics

**Vishay Semiconductors** 



 $\begin{array}{l} \mbox{Fig. 9 - Typical IGBT Energy Loss vs. I_C} \\ \mbox{T_J} = 125 \ ^{\circ}\mbox{C}, \ \mbox{L} = 500 \ \mbox{\mu}\mbox{H}, \ \mbox{V}_{CC} = 600 \ \mbox{V}, \\ \mbox{R}_{g} = 5 \ \mbox{\Omega}, \ \ \mbox{V}_{GE} = 15 \ \mbox{V} \end{array}$ 

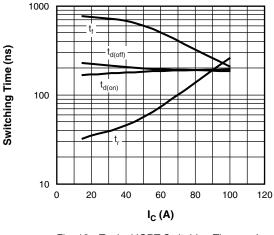


Fig. 10 - Typical IGBT Switching Time vs. I<sub>C</sub>  $T_J$  = 125 °C, L = 500 µH, V<sub>CC</sub> = 600 V,  $R_g$  = 5  $\Omega$ , V<sub>GE</sub> = 15 V

Revision: 11-Jun-15

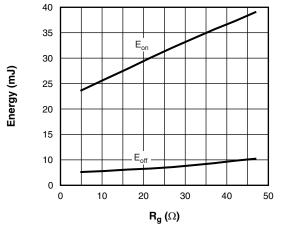
Document Number: 93100

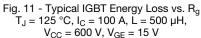
For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

4



## **Vishay Semiconductors**





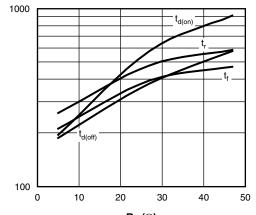
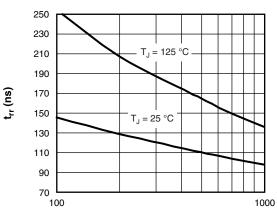


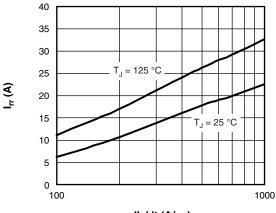


Fig. 12 - Typical IGBT Switching Time vs.  $R_g$   $T_J$  = 125 °C, L = 500  $\mu H,$   $V_{CC}$  = 600 V,  $I_C$  = 100 A,  $V_{GE}$  = 15 V



dl<sub>F</sub>/dt (A/µs)

Fig. 13 - Typical  $t_{rr}$  Diode vs. dI\_F/dt  $V_R$  = 200 V, I\_F = 50 A



dl<sub>F</sub>/dt (A/µs)

Fig. 14 - Typical I<sub>rr</sub> Diode vs. dI<sub>F</sub>/dt V<sub>R</sub> = 200 V, I<sub>F</sub> = 50 A

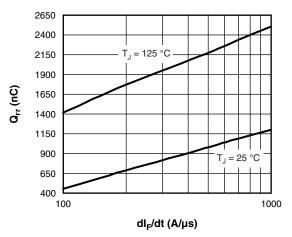


Fig. 15 - Typical Q<sub>rr</sub> Diode vs. dI<sub>F</sub>/dt  $V_R = 200 \text{ V}, \text{ I}_F = 50 \text{ A}$ 

For technical questions within your region: <u>DiodesAmericas@vishay.com</u>, <u>DiodesAsia@vishay.com</u>, <u>DiodesEurope@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>

Switching Time (ns)

**Vishay Semiconductors** 

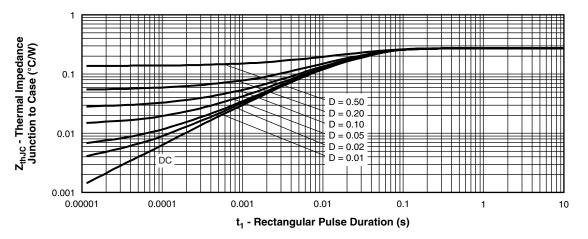


Fig. 16 - Maximum Thermal Impedance ZthJC Characteristics (IGBT)

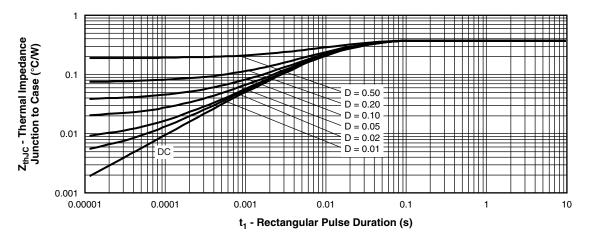


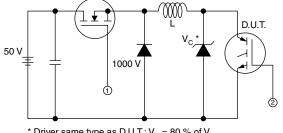
Fig. 17 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics (Diode)

ISHA

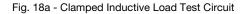
www.vishay.com



## **Vishay Semiconductors**



\* Driver same type as D.U.T.; V<sub>C</sub> = 80 % of V<sub>ce(max)</sub>
\* Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id



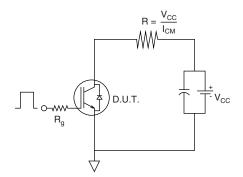


Fig. 18b - Pulsed Collector Current Test Circuit

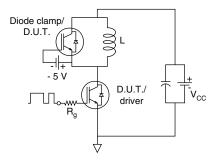


Fig. 19a - Switching Loss Test Circuit

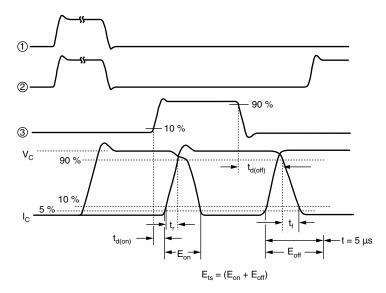


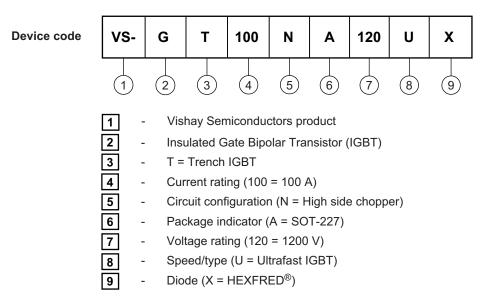
Fig. 19b - Switching Loss Waveforms Test Circuit



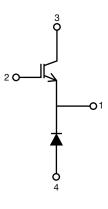
### **Vishay Semiconductors**



### **ORDERING INFORMATION TABLE**



### **CIRCUIT CONFIGURATION**



LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95036					
Packaging information	www.vishay.com/doc?95037				

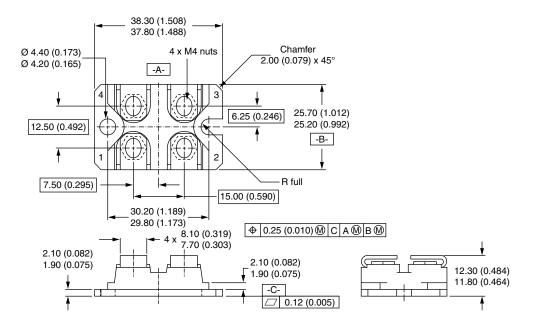


**Vishay Semiconductors** 



SOT-227

### **DIMENSIONS** in millimeters (inches)



#### Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



Vishay

# Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Material Category Policy**

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.